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PATENT

Case Docket No. MICRON.246A
Date: August 12, 2002

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : Farrar et al.
Appl. No. : 09/945,024
Filed : August 30, 2001
For : MULTI-CHIP
ELECTRONIC PACKAGE
AND COOLING SYSTEM
Examiner : Gregory Thompson

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Attorney of Record

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